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By: [Signature]

BRENDY BELONY

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Attorney Docket No.: NECF 18.363A

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor : **Hirokazu HONDA**

Serial No. :

Filed : **January 21, 2004**

Title : **FLIP-CHIP TYPE SEMICONDUCTOR DEVICE AND
METHOD OF MANUFACTURING THE SAME**

Examiner :

Group Art Unit :

Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

PRELIMINARY AMENDMENT

S I R:

Prior to examination on the merits, please amend the above-captioned application as follows: